

## Technical Data

### Product Description

Arlon 25N and 25FR are woven fiberglass reinforced, ceramic-filled composite materials engineered for use in microwave and RF multilayer printed circuit boards. Combining a non-polar thermoset resin system with a controlled-expansion ceramic filler, 25N and 25FR offer low dielectric constant and loss combined with a low Thermal Coefficient of Dielectric Constant (TCER) for signal stability over a wide ambient temperature range. Designed for use in multilayer packages, 25N and 25FR offer prepregs that are identical in chemical composition and physical properties with their copper clad laminates for a completely homogeneous finished package for optimal signal integrity.

The low dielectric constant (Er) and loss properties, low thermal coefficient of dielectric constant (TCER), and excellent physical stability characteristics offered by 25N and 25FR materials make them ideal for wireless and digital applications, such as cellular telephones, down converters, low noise amplifiers, antennas and other advanced design circuits.

Processing for 25N and 25FR materials is consistent with processing for standard high temperature thermoset based printed circuit board substrates.

### General

|                         |   |
|-------------------------|---|
| Material Status         | • Commercial: Active                              |
| Literature <sup>1</sup> | • <a href="#">Technical Datasheet (English)</a>   |
| Availability            | • Asia Pacific • Europe • North America           |
| Filler / Reinforcement  | • Ceramic Fiber • Glass Fiber                     |
| Features                | • Fast Molding Cycle • Good Dimensional Stability |
| Uses                    | • Electrical/Electronic Applications              |
| Forms                   | • Pellets   |

| Physical   | Nominal Value (English)           | Nominal Value (SI)     | Test Method     |
|--|-----------------------------------|------------------------|-----------------|
| Density / Specific Gravity <sup>3</sup>                  | 1.70                              | 1.70 g/cm <sup>3</sup> | ASTM D792A      |
| Water Absorption <sup>4</sup> (24 hr, 73°F (23°C))       | 0.090 %                           | 0.090 %                | Internal Method |
| Volatile Matter <sup>5</sup>                             | 0.010 %                           | 0.010 %                |                 |
| Mechanical   | Nominal Value (English)           | Nominal Value (SI)     | Test Method     |
| Flexural Strength (73°F (23°C))                          | 30200 psi                         | 208 MPa                | ASTM D790A      |
| Films  | Nominal Value (English)           | Nominal Value (SI)     | Test Method     |
| Tensile Strength - MD <sup>3</sup> (Yield)               | 16100 psi                         | 111 MPa                | ASTM D882A      |
| Peel Strength <sup>6</sup>                               | 5.0 lbf/in                        | 875.6 N/m              | Internal Method |
| Thermal  | Nominal Value (English)           | Nominal Value (SI)     | Test Method     |
| CLTE - Flow  |                                   |                        |                 |
| -- <sup>7</sup>  | 8.3E-6 in/in/°F                   | 1.5E-5 cm/cm/°C        | Internal Method |
| -- <sup>8</sup>  | 2.9E-5 in/in/°F                   | 5.2E-5 cm/cm/°C        | Internal Method |
| Thermal Conductivity (212°F (100°C))                     | 3.1 Btu·in/hr/ft <sup>2</sup> /°F | 0.45 W/m/K             | ASTM E1225      |
| Electrical   | Nominal Value (English)           | Nominal Value (SI)     | Test Method     |
| Surface Resistivity                                      | 4.4E+14 ohms                      | 4.4E+14 ohms           | Internal Method |
| Volume Resistivity                                       | 2.0E+9 ohms·cm                    | 2.0E+9 ohms·cm         | Internal Method |
| Dielectric Constant <sup>9</sup> (73°F (23°C), 10.0 GHz) | 3.38                              | 3.38                   | Internal Method |
| Dissipation Factor <sup>9</sup> (10.0 GHz)               | 2.5E-3                            | 2.5E-3                 | Internal Method |
| Additional Information                                   | Nominal Value (English)           | Nominal Value (SI)     |                 |
| Total Mass Loss <sup>10</sup> (257°F (125°C))            | > 0.17 %                          | > 0.17 %               |                 |
| Water Vapor - Recovered                                  | 0.020 %                           | 0.020 %                |                 |

**Notes**

- <sup>1</sup> These links provide you with access to supplier literature. We work hard to keep them up to date; however you may find the most current literature from the supplier.
- <sup>2</sup> Typical properties: these are not to be construed as specifications.
- <sup>3</sup> 23°C
- <sup>4</sup> E1/105 + D24/23
- <sup>5</sup> Maximum 0.10%
- <sup>6</sup> After Thermal Stress
- <sup>7</sup> X-axis
- <sup>8</sup> Z-axis
- <sup>9</sup> C23/50
- <sup>10</sup> < 10e-6 torr, Maximum 1.00%



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## Where to Buy

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### Supplier

#### **Arlon-MED**

Rancho Cucamonga, Rancho Cucamonga USA

**Telephone:** 909-987-9533

**Web:** <http://www.arlon-med.com/index.html>

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### Distributor

Please contact the supplier to find a distributor for Arlon® 25N

